

Low Capacitance TVS Diode

• ESD / transient protection of high-speed data lines in 3.3 / 5 / 12 V applications according to:

IEC61000-4-2 (ESD): up to \pm 25 KV (contact) IEC61000-4-4 (EFT): up to 4 kV (5/50 ns) IEC61000-4-5 (surge): up to 2.5 A (8/20 µs)

- Smallest form factor down to 1.0 x 0.6 x 0.4 mm
- Max. working voltage: ±8 / +14 V
- Very low capacitance down to 2 pF
- Very low reverse current < 0.1 μA
- Very low series inductance down to 0.4 nH

Applications

- USB 2.0, 10/100 Ethernet, Firewire, DVI
- Mobile communication
- Consumer products (STB, MP3, DVD, DSC...)
- LCD displays, camera
- Notebooks and destop computers, peripherals

ESD8V0L1B-02LRH

ESD8V0L2B-03L ESD8V0L2B-03LRH





ESD8V0L2B



Туре	Package	Configuration	Marking
ESD8V0L1B-02LRH	TSLP-2-7	1 channel, bi-directional	B3
ESD8V0L2B-03L	TSLP-3-1	2 channels, bi-directional	B3
ESD8V0L2B-03LRH*	TSLP-3-7	2 channels, bi-directional	on request
ESD8V0L2B**	SOT23	2 channels, bi-directional	on request

Preliminary data

** Target data

2007-02-20



Maximum Ratings at $T_A = 25^{\circ}$ C, unless otherwise specified

Parameter	Symbol	Value	Unit	
ESD contact discharge ¹⁾	V _{ESD}		kV	
ESD8V0L1B-02LRH		25		
ESD8V0L2B, between all pins		15		
Peak pulse current ($t_p = 8 / 20 \ \mu s$) ²⁾	/ _{pp}		Α	
ESD8V0L1B-02LRH		2.5		
ESD8V0L2B		1		
Operating temperature range	T _{op}	-55125	°C	
Storage temperature	T _{stg}	-65150		

Electrical Characteristics at $T_A = 25^{\circ}$ C, unless otherwise specified

Parameter	Symbol	Values			Unit
		min.	typ.	max.	
Characteristics					
Reverse working voltage	V _{RWM}	-8	-	14	V
Breakdown voltage	V _(BR)				
$I_{(BR)}$ = 1 mA, from pin 2 to 1, ESD8V0L1B-02LRH		14.5	-	-	
$I_{(BR)}$ = 1 mA, from pin 1 to 2, ESD8V0L1B-02LRH		8.5	-	-	
$I_{(BR)}$ = 1 mA, from pin 1/2 to 3, ESD8V0L2B		14.5	-	-	
$I_{(BR)}$ = 1 mA, from pin 3 to 1/2, ESD8V0L2B		8.5	-	-	
$I_{(BR)}$ = 1 mA, from pin 1 to 2, ESD8V0L2B		23	-	-	
Reverse current	I _R	-	< 1	100	nA
V_{R} = 3 V, between all pins					
Clamping voltage for ESD8V0L2B	V _{CL}				V
V_{ESD} = +15 kV (contact) ¹⁾ , from pin 1/2 to 3		-	26	-	
V_{ESD} = -15 kV (contact) ¹⁾ , from pin 1/2 to 3		-	20	-	
Line capacitance ³⁾	CT				pF
<i>V</i> _R = 0 V, <i>f</i> = 1 MHz, ESD8V0L1B-02LRH		-	8.5	13	
<i>V</i> _R = 0 V, <i>f</i> = 1 MHz, ESD8V0L2B,					
from pin 1/2 to 3		-	4	7	
from pin 1 to 2, pin 3 is not connected		-	2	4	

 $^{1}\mathrm{V}_{ESD}$ according to IEC61000-4-2

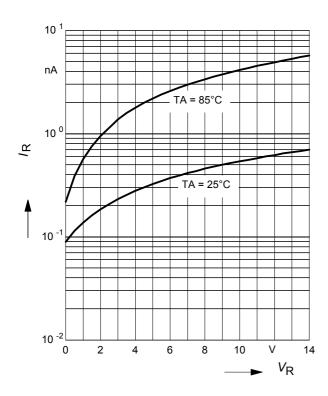
 $^{2}I_{pp}$ according to IEC61000-4-5

³Total capacitance line to ground



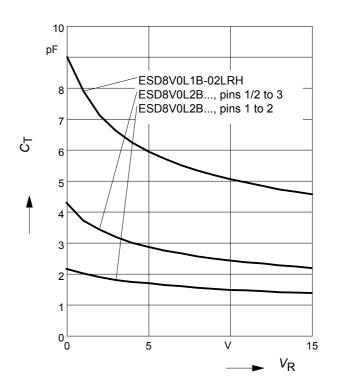
Reverse current $I_{R} = f(V_{R})$

 T_A = Parameter



Diode capacitance $C_{T} = f(V_{R})$

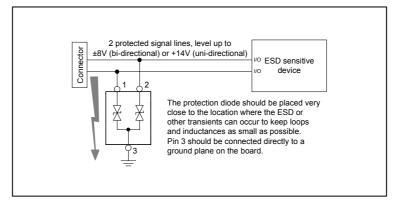
f = 1MHz





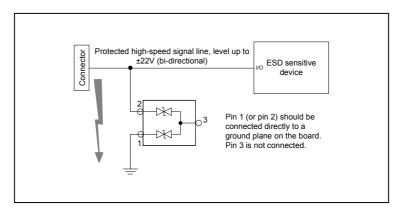
Application example ESD8V0L2B...

2 channels, bi-directional



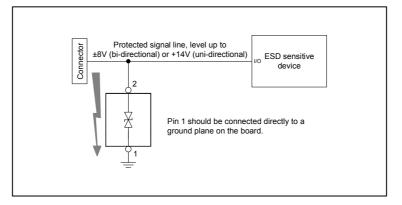
Application example ESD8V0L2B...

1 high-speed channel, bi-directional

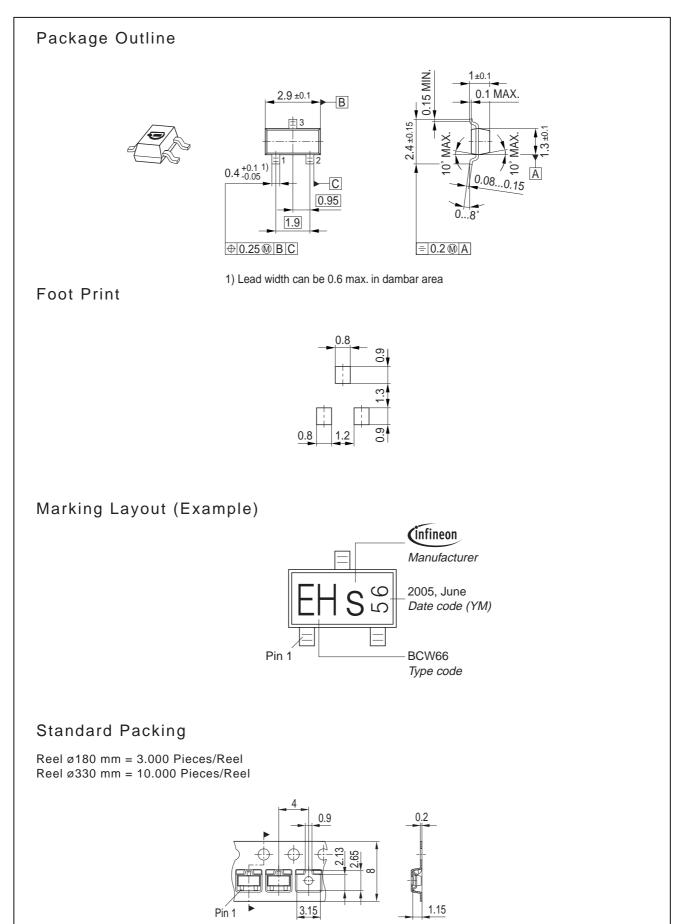


Application example ESD8V0L1B-02LRH

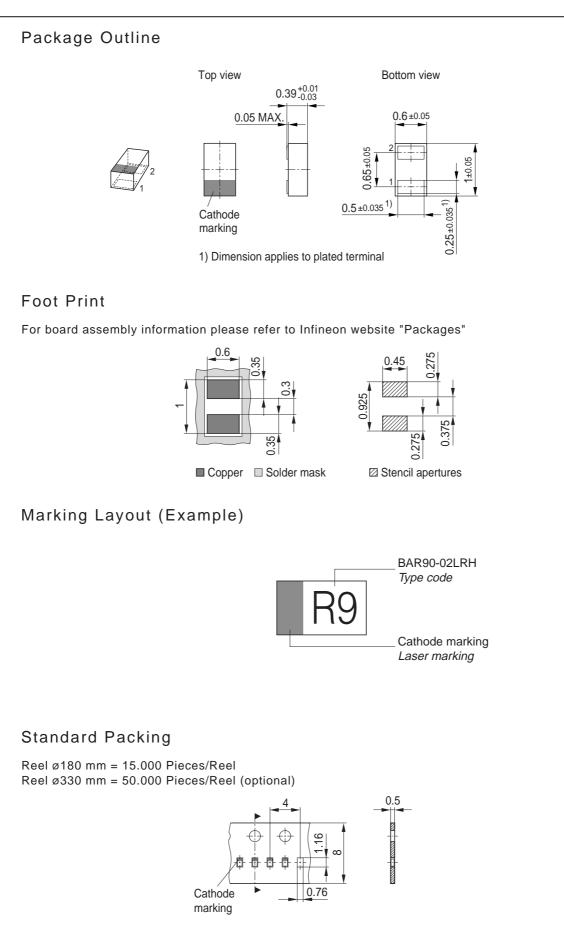
1 channel, bi-directional





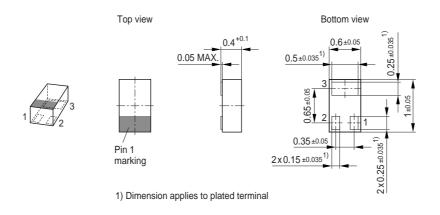






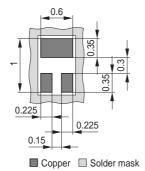


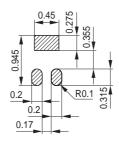




Foot Print

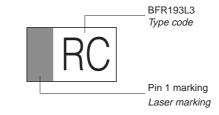
For board assembly information please refer to Infineon website "Packages"





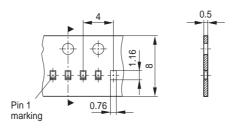
Stencil apertures

Marking Layout (Example)

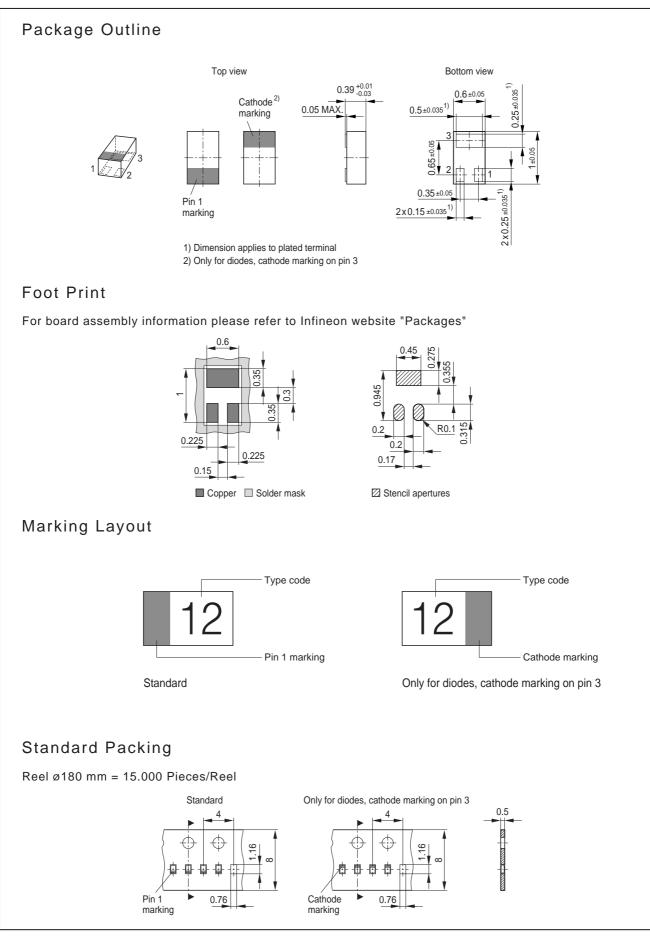


Standard Packing

Reel ø180 mm = 15.000 Pieces/Reel









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